

Automotive MOSFET

OptiMOS™-5 Power-Transistor







Features

- OptiMOS[™] power MOSFET for automotive applications
- N-channel Enhancement mode Logic Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested



General automotive applications.

Product validation

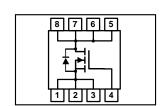
Qualified for automotive applications. Product validation according to AEC-Q101.

Product Summary

V_{DS}	60	V
R _{DS(on)}	7.3	mΩ
I _D (chip limited)	60	Α

Туре	Package	Marking
IAUC60N06S5L073	PG-TDSON-8-33	5N06L073





IAUC60N06S5L073



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Maximum ratings

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I _D	V _{GS} =10 V, Chip limitation ^{1,2)}	60	А
		V _{GS} =10V, DC current	60	
		T_a =85 °C, V_{GS} =10 V, R_{thJA} on 2s2p ^{2,4)}	15	
Pulsed drain current ²⁾	I _{D,pulse}	T _C =25 °C, t _p = 100 μs	168]
Avalanche energy, single pulse ²⁾	E AS	/ _D =30 A	40	mJ
Avalanche current, single pulse	I _{AS}	-	60	А
Gate source voltage	V _{GS}	-	±16	V
Power dissipation	P _{tot}	T _C =25 °C	52	W
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-	-55 + 175	°C
IEC climatic category; DIN IEC 68-1	_	-	55/175/56	

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Thermal characteristics²⁾

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.]
Thermal resistance, junction - case	R thJC	-	-	-	2.9	K/W
Thermal resistance, junction - ambient ⁴⁾	R _{thJA}	-	-	24.8	_	

Electrical characteristics

at Tj=25 °C, unless otherwise specified

Parameter	Symbol Conditions	Values			Unit	
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V_{GS} =0 V, I_D =1 mA	60	_	-	v
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 19 \mu A$	1.2	1.7	2.2	
Zero gate voltage drain current	I _{DSS}	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	-	_	1	μΑ
		V_{DS} =60 V, V_{GS} =0 V, T_{j} =100 °C ²)	-	_	100	
Gate-source leakage current	I _{GSS}	V _{GS} =16 V, V _{DS} =0 V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =30 A	_	8.2	9.8	mΩ
		V _{GS} =10 V, I _D =30 A	_	6.0	7.3	
Gate resistance ²⁾	R _G	-	-	1.3	_	Ω

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Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	1
Dynamic characteristics ²⁾						
Input capacitance	C iss		-	1273	1655	pF
Output capacitance	C oss	V_{GS} =0 V, V_{DS} =30 V, f =1 MHz	-	277	360	
Reverse transfer capacitance	C _{rss}		-	14	21	
Turn-on delay time	t d(on)		-	2.8	_	ns
Rise time	t _r	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A,	-	2.3	_	
Turn-off delay time	t d(off)	$R_{\rm G}$ =3.5 Ω	-	8.4	_	
Fall time	t f		_	4.8	_	
Gate to drain charge	Q gs Q gd	V _{DD} =30 V, I _D =30 A, V _{GS} =0 to 10 V	-	2.8	5.5 4.2	nC
Gate charge total	Q _g		-	17.4	22.6	
Gate plateau voltage	$V_{\rm plateau}$		-	3.3	-	V
Reverse Diode						
Diode continous forward current ²⁾	I _S	<i>T</i> _C =25 °C	-	_	60	Α
Diode pulse current ²⁾	I _{S,pulse}	T _C =25 °C, t _p = 100 μs	-	-	168	
Diode forward voltage	V_{SD}	V_{GS} =0 V, I_{F} =30 A, T_{j} =25 °C	-	0.8	1.1	V
Reverse recovery time ²⁾	t _{rr}	V_R =30 V, I_F =50 A, d i_F /d t =100 A/ μ s	-	28	_	ns
Reverse recovery charge ²⁾	Q rr		_	17.0	_	nC

¹⁾ Practically the current is limited by the overall system design including the customer-specific PCB.

²⁾ The parameter is not subject to production testing – specified by design.

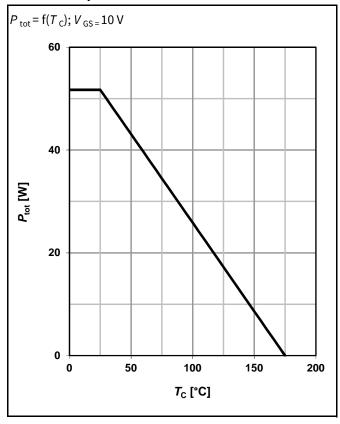
³⁾ Current is limited by the package.

⁴⁾ Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

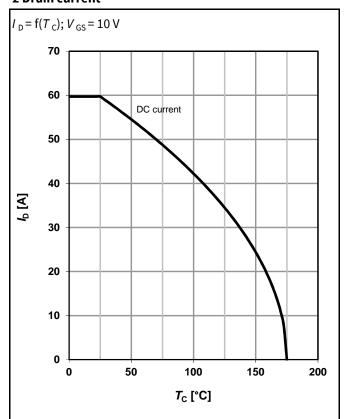


Electrical characteristics diagrams

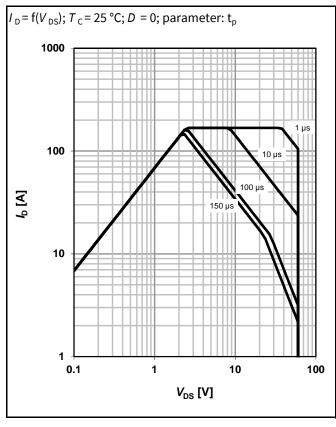
1 Power dissipation



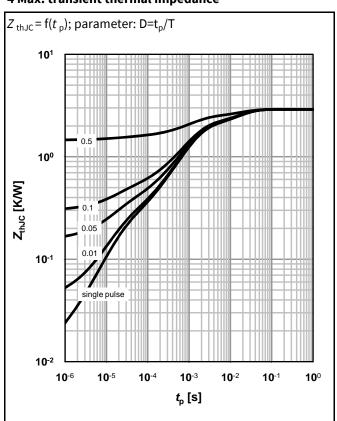
2 Drain current



3 Safe operating area



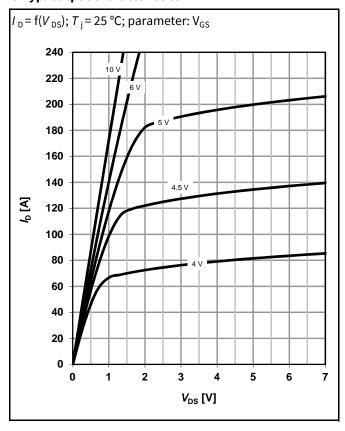
4 Max. transient thermal impedance



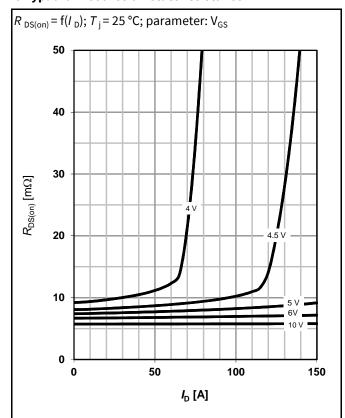
6



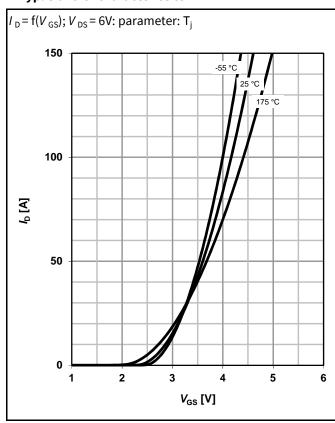
5 Typ. output characteristics



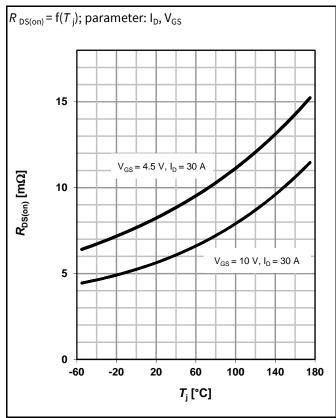
6 Typ. drain-source on-state resistance



7 Typ. transfer characteristics

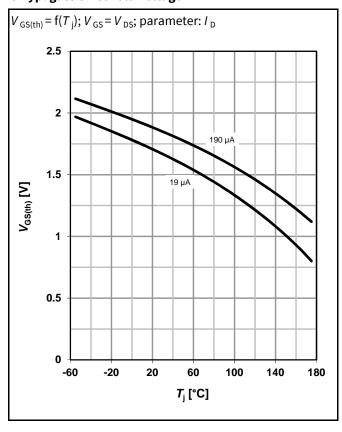


8 Typ. drain-source on-state resistance

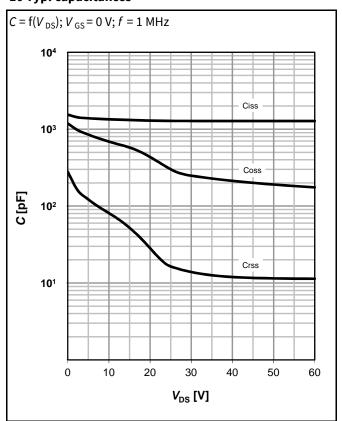


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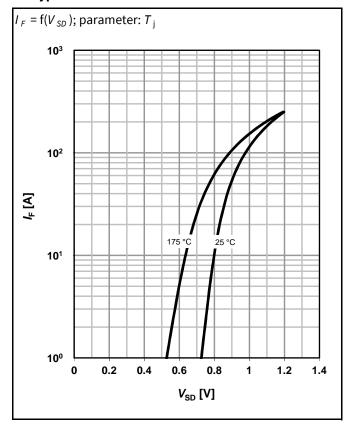
9 Typ. gate threshold voltage



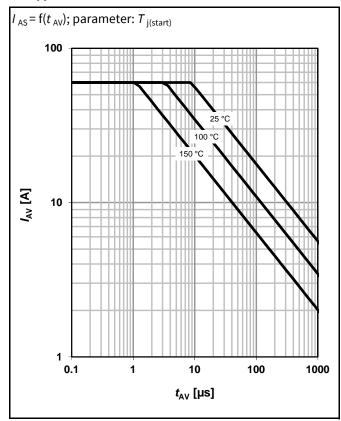
10 Typ. capacitances



11 Typical forward diode characteristics

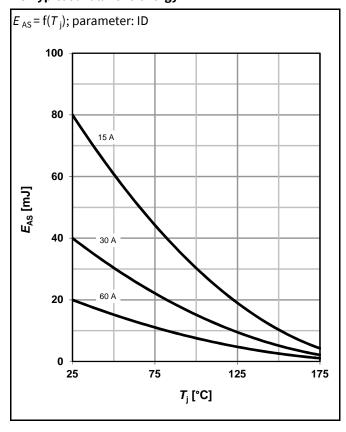


12 Typ. avalanche characteristics

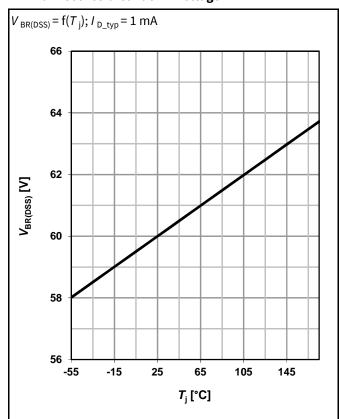


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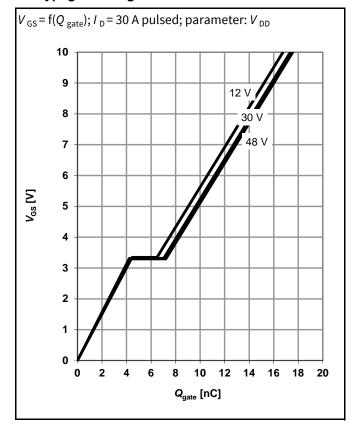
13 Typical avalanche energy



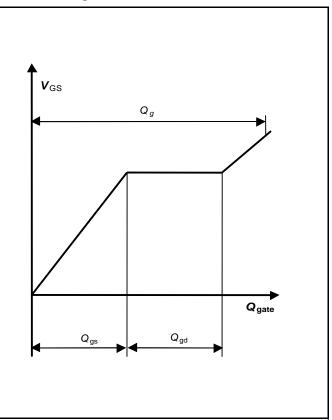
14 Drain-source breakdown voltage



15 Typ. gate charge



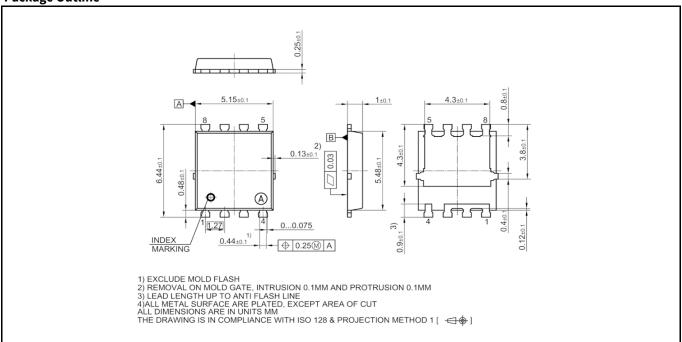
16 Gate charge waveforms



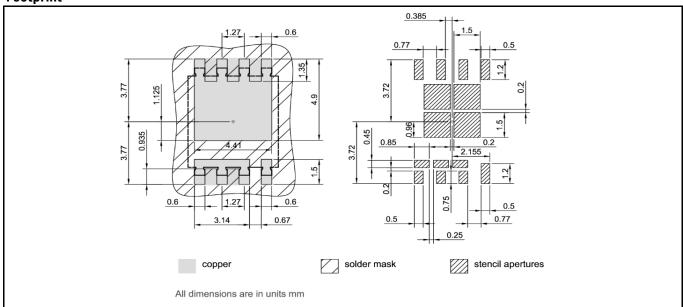
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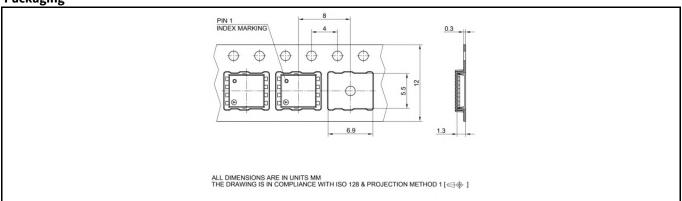
Package Outline



Footprint



Packaging



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Revision History

Revision	Date	Changes
Revision 1.0	04.05.2021	final data sheet
Revision 1.1	01.10.2021	normal level -> logic level (page 1)
Revision 1.2	27.01.2022	update image for pin layout (page 1)

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